MPSW55, MPSW56

One Watt Amplifier Transistors

PNP Silicon

Features

• Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector - Emitter Voltage	MPSW55 MPSW56	V _{CEO}	-60 -80	Vdc
Collector - Base Voltage	MPSW55 MPSW56	V _{CBO}	-60 -80	Vdc
Emitter - Base Voltage	V _{EBO}	-4.0	Vdc	
Collector Current - Continuous	I _C	-500	mAdc	
Total Device Dissipation @ T _A : Derate above 25°C	P _D	1.0 8.0	W mW/°C	
Total Device Dissipation @ T _C Derate above 25°C	P _D	2.5 20	W mW/°C	
Operating and Storage Junction Temperature Range	n	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

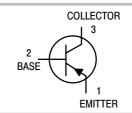
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	125	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	50	°C/W

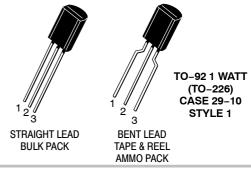
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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MARKING DIAGRAM



= 5 or 6

Α = Assembly Location

= Year = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MPSW55G	TO-92 (Pb-Free)	5000 Units/Bulk
MPSW55RLRAG	TO-92 (Pb-Free)	2000/Tape & Reel
MPSW56RLRP	TO-92	2000/Ammo Pack
MPSW56RLRPG	TO-92 (Pb-Free)	2000/Ammo Pack

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MPSW55, MPSW56

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS			-		
Collector – Emitter Breakdown Voltage (Note 1) $(I_C = -1.0 \text{ mAdc}, I_B = 0)$	MPSW55 MPSW56	V _(BR) CEO	-60 -80	- -	Vdc
Emitter – Base Breakdown Voltage ($I_E = -100 \mu Adc, I_C = 0$)		V _{(BR)EBO}	-4.0	_	Vdc
Collector Cutoff Current $(V_{CE} = -40 \text{ Vdc}, I_B = 0)$ $(V_{CE} = -60 \text{ Vdc}, I_B = 0)$	MPSW55 MPSW56	I _{CES}	- -	-0.5 -0.5	μAdc
Collector Cutoff Current	MPSW55 MPSW56	I _{CBO}	- -	-0.1 -0.1	μAdc
Emitter Cutoff Current (V _{EB} = -3.0 Vdc, I _C = 0)		I _{EBO}	-	-0.1	μAdc
ON CHARACTERISTICS ⁽¹⁾					
DC Current Gain ($I_C = -50$ mAdc, $V_{CE} = -1.0$ Vdc) ($I_C = -250$ mAdc, $V_{CE} = -1.0$ Vdc)		h _{FE}	100 50		-
Collector – Emitter Saturation Voltage (I _C = -250 mAdc, I _B = -10 mAdc)		V _{CE(sat)}	-	-0.5	Vdc
Base-Emitter On Voltage (I _C = -250 mAdc, V _{CE} = -5.0 Vdc)		V _{BE(on)}	-	-1.2	Vdc
SMALL-SIGNAL CHARACTERISTICS					
Current – Gain — Bandwidth Product (I _C = -250 mAdc, V _{CE} = -5.0 Vdc, f = 20 MHz)		f _T	50	_	MHz
Output Capacitance (V _{CB} = -10 Vdc, f = 1.0 MHz)		C _{obo}	-	15	pF

^{1.} Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

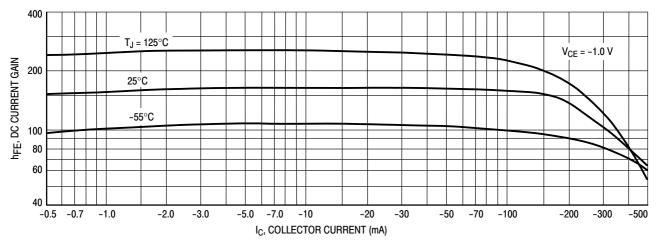


Figure 1. DC Current Gain

MPSW55, MPSW56

100

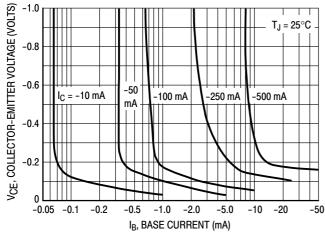


Figure 2. Collector Saturation Region

-0.2-2.0 -50

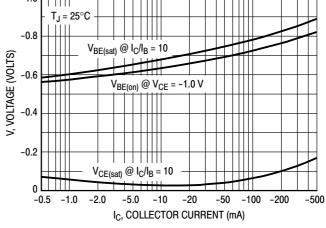
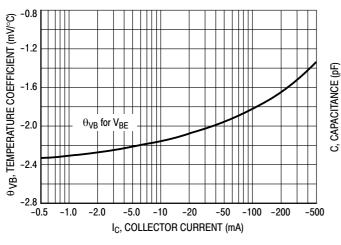


Figure 3. "On" Voltages



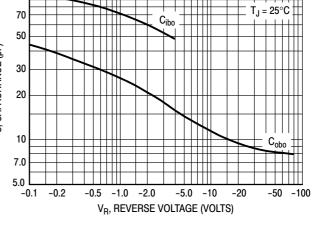
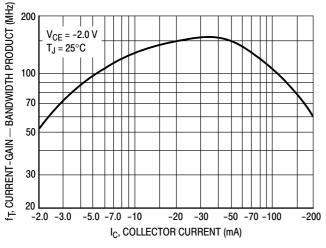
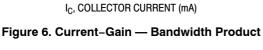


Figure 4. Base-Emitter Temperature Coefficient

Figure 5. Capacitance





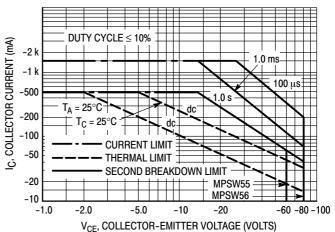
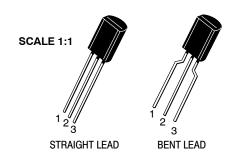


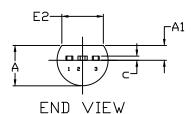
Figure 7. Active Region — Safe Operating Area

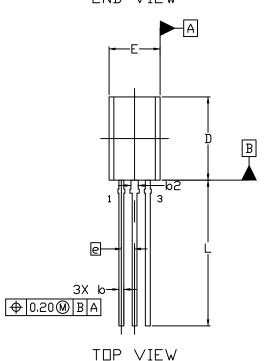


TO-92 (TO-226) 1 WATT CASE 29-10 ISSUE D

DATE 05 MAR 2021

STRAIGHT LEAD





NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS.
- 4. DIMENSION 6 AND 62 DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 0.20. DIMENSION 62 LOCATED ABOVE THE DAMBAR PORTION OF MIDDLE LEAD.

	MILLIMETERS						
DIM	MIN.	N□M.	MAX.				
Δ	3.75	3.90	4.05				
A1	1.28	1.43	1.58				
Ø	0.38	0.465	0.55				
ρQ	0.62	0.70	0.78				
C	0.35	0.40	0.45				
D	7.85	8.00	8.15				
E	4.75	4.90	5.05				
E2	3.90						
е	1.27 BSC						
L	13.80	14.00	14.20				

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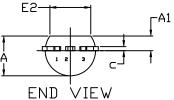
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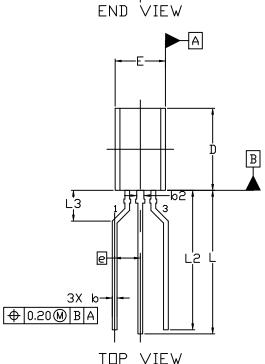


TO-92 (TO-226) 1 WATT CASE 29-10 ISSUE D

DATE 05 MAR 2021

FORMED LEAD





NOTES:

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С	0.35	0.40	0.45				
D	7.85	8.00	8.15				
Е	4.75	4.90	5.05				
E2	3.90						
е		2.50 BSC					
L	13.80	14.00	14.20				
L2	13.20	13.60	14.00				
L3	3.00 REF						

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DATE 05 MAR 2021

STYLE 1: PIN 1. 2. 3.	EMITTER BASE COLLECTOR	STYLE 2: PIN 1. 2. 3.	BASE EMITTER COLLECTOR	STYLE 3: PIN 1. 2. 3.	ANODE ANODE CATHODE	PIN 1.	CATHODE CATHODE ANODE		DRAIN SOURCE GATE
	GATE	PIN 1.	SOURCE DRAIN	PIN 1. 2.	DRAIN GATE	STYLE 9: PIN 1. 2. 3.	BASE 1 EMITTER		
2.	CATHODE & ANODE	2.	MAIN TERMINAL 1 GATE MAIN TERMINAL 2	2.	ANODE 1 GATE CATHODE 2	2.	EMITTER		
2.	ANODE	PINI 1	COLLECTOR BASE EMITTER	PIN 1	ANODE	DINI 1		2.	NOT CONNECTED CATHODE ANODE
2.			GATE	PIN 1. 2.	GATE SOURCE DRAIN	PIN 1. 2.	EMITTER COLLECTOR/ANODE CATHODE	PIN 1. 2.	
	V _{CC}		MT SUBSTRATE	PIN 1. 2.	CATHODE	PIN 1. 2.		PIN 1. 2.	
		STYLE 32: PIN 1. 2. 3.	BASE COLLECTOR EMITTER	STYLE 33: PIN 1. 2. 3.	RETURN	PIN 1. 2.	INPUT GROUND LOGIC		

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

A = Assembly Location

L = Wafer Lot Y = Year

W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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